# 2SD2300

# Silicon NPN Triple Diffused

# **HITACHI**

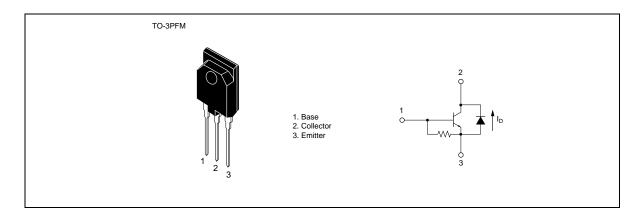
### **Application**

CTV horizontal deflection output

#### **Features**

- High breakdown voltage  $V_{\text{CBO}} = 1500 \text{ V}$
- Built-in damper diode type

#### **Outline**



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### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

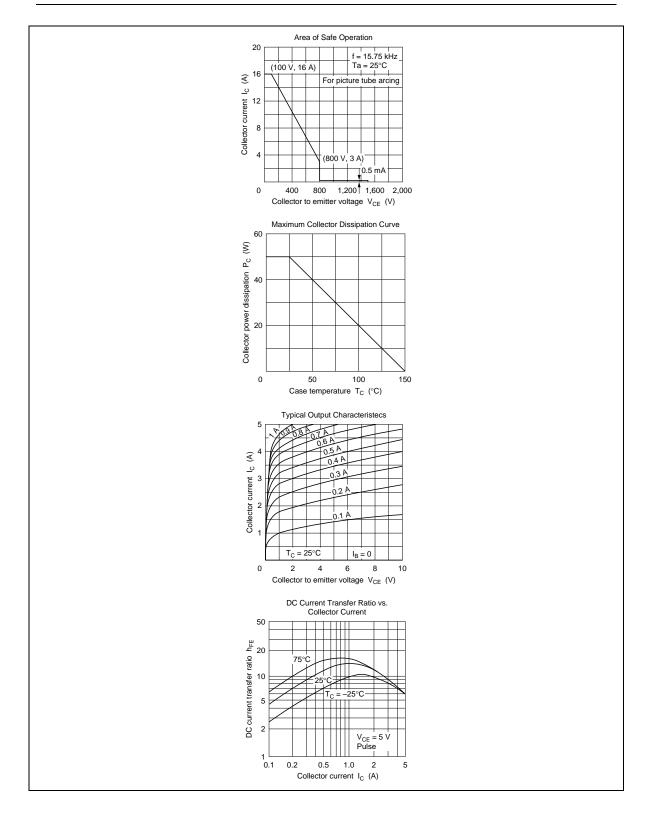
Item	Symbol	Ratings	Unit
Collector to emitter voltage	V <sub>CES</sub>	1500	V
Emitter to base voltage	V <sub>EBO</sub>	6	V
Collector current	I <sub>c</sub>	5	A
Collector peak current	I <sub>C(peak)</sub>	6	A
Collector surge current	I <sub>C(surge)</sub>	16	A
Collector power dissipation	P <sub>c</sub> *¹	50	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C
C to E diode forward current	I <sub>D</sub>	6	A

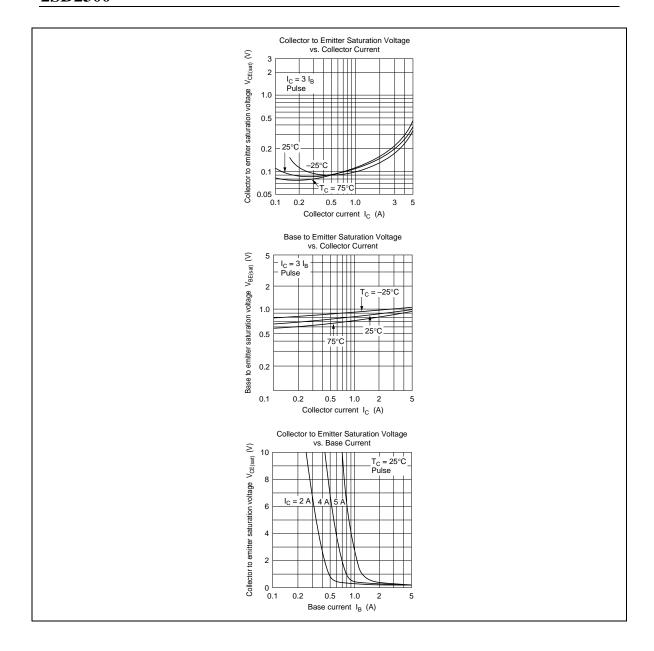
Note: 1. Value at  $T_c = 25$ °C.

### **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Emitter to base breakdown voltage	$V_{_{(BR)EBO}}$	6	_	_	V	$I_{\rm E}$ = 350 mA, $I_{\rm C}$ = 0
Collector cutoff current	I <sub>CES</sub>	_	_	500	μΑ	$V_{CE} = 1500 \text{ V}, R_{BE} = 0$
DC current transfer ratio	h <sub>FE</sub>	_	_	20		$V_{CE} = 5 \text{ V}, I_{C} = 1 \text{ A}$
Collector to emitter saturation voltage	$V_{\scriptscriptstyle{CE(sat)}}$	_	_	5	V	$I_{c} = 4.5 \text{ A}, I_{B} = 1.2 \text{ A}$
Base to emitter saturation voltage	$V_{\scriptscriptstyle{BE(sat)}}$	_	_	1.5	V	$I_{c} = 4.5 \text{ A}, I_{B} = 1.2 \text{ A}$
C to E diode forward voltage	V <sub>ECF</sub>	_	_	3.0	V	I <sub>F</sub> = 6 A
Fall time	t <sub>f</sub>	_	_	1.0	μs	$I_{CP} = 4 \text{ A}, I_{B1} = 0.8 \text{ A},$ $I_{B2} \approx -1.5 \text{ A}$

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